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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Venkateswaran

Docket Number: TI-34105.1

Serial No.: 10/789,646

Art Unit: 2813

Filed: 03/01/2004

Examiner: J. Dolan

For: ARRANGEMENT IN SEMICONDUCTOR PACKAGES FOR ...

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NAME OF INVENTOR(S): Venkateswaran		RECEIPT DATE & SERIAL NO.: Serial No.: 10/789,646
TITLE OF INVENTION: Semiconductor Device Package and...		Conf. No: 9162
TI FILE NO.: TI-34105.1	DEPOSIT ACCT. NO.: 20-0668	
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